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Mechanical switching in ferroelectrics by shear stress and its implications on charged domain wall generation and vortex memory devices

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Recently, the resurgence of interest in flexoelectricity in solids has promoted research on switching of ferroelectric domains *via* mechanical loads. In this work, combining thermodynamic calculation and phase-field simulation, we revealed that mechanical switching of polarization can be achieved in ferroelectrics by shear stress *via* a simple mechanism where the presence of flexoelectricity is not necessary. The switching is a consequence of the trilinear coupling between shear stress and the two polarization components that lie in the shear strain plane. Specifically, when the direction of one polarization component is fixed, switching of the other component can be induced by applying a shear stress. Moreover, when the shear stress is fixed, switching of one of the polarization components can lead to the switching of the other component. Phase diagrams of the stable polarization state as a function of shear stress, temperature and electric field are calculated. Furthermore, as demonstrated by phase-field simulation on a ferroelectric thin film, domain switching can indeed be realized by a local shear stress. Importantly, the combining effect of shear stress and electric field can lead to a deterministic writing of charged domain walls, which should be very useful for the fabrication of domain wall devices. The implication of such a shear-stress-modified polarization switching on the design of vortex memory device is also discussed.

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Introduction

'Ferroelectrics' refers to a class of materials that exhibit a spontaneous polarization P below a temperature point and P is switchable under an electric field E . This attribute makes them promising in developing nonvolatile memory devices.¹ Ferroelectrics also have wonderful applications such as in sensors,² actuators,³ energy conversion/storage devices,^{4–6} optical switches,⁷ microwave devices,⁸ *etc.*, due to a wide spectrum of other functional properties including piezoelectricity, pyroelectricity, electro-optic effects, and nonlinear dielectric/optic behavior. Importantly, the properties of ferroelectrics generally exhibit dependence on the polarization state and the domain structure, and it is well-known that the polarization state and the domain structure of ferroelectrics are strongly coupled to external thermal, electrical and mechanical fields.^{9–11} These features indicate abundant controllability of ferroelectric devices *via* domain engineering.

Due to the direct coupling between polarization P and electric field E , it is natural to manipulate (*e.g.*, switch, reorient or erase) ferroelectric domains electrically. As the applied field is required to be larger than the coercive field, which is usually in order of 10^7 to 10^8 V m^{−1}, electric-field-driven processes such as charge injection (extraction) from (into) the electrode, electrochemical process near the electrode/ferroelectric interface, and charged defect migration can be quite significant. While it is still under debate, the injected charges or mobile defects are believed to be captured by the interface (and form a space charge layer which decreases the effective field applied and depresses domain inversion) or by the charged domain walls that appear during domain switching (and consequently pin the domain walls and depresses domain inversion). As a consequence, fatigue problem is quite difficult to avoid.^{12,13} While internal electric field might also play an important role, fatigue problem, at least the contribution from charge injection, is expected to be largely eased if external electric field is absent. Electrical switching also causes complex memristive dynamics,^{14,15} leakage and even dielectric break-down problem. It is therefore desirable to identify possible effects that can facilitate domain switching and alternative switching strategies using nonelectrical fields.

Most ferroelectric phase transition behaviors are caused by the collective lattice distortions. Consequently, ferroelectric polarization is intrinsically coupled with stress and strain fields.

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However, it is not a common idea to apply mechanical fields to switch ferroelectric domains. This is because stress σ or strain ε is coupled with ferroelectric polarization P in an even symmetry, *i.e.*, $-\sigma P^2$ or $-\varepsilon P^2$. The switching of P to $-P$ would not change the system's energy. Nevertheless, it should be pointed out that this argument is only applicable to perfect 180° switching and to homogeneous system. On the one hand, it is well-known that ferroelectric domains can be reoriented by strain or stress, such as strain-induced transformation from a domain to c domain in a ferroelastic domain pattern. On the other hand, when the system is inhomogeneous, *e.g.*, subjected to inhomogeneous stress/strain state, or with surfaces/interfaces, other effects can enter into the role in facilitating mechanical switching of ferroelectric domains. For example, it has been realized that strain gradient can lead to 180° switching of polarization in a similar way of electric field, namely flexoelectricity. This is because strain gradient is an odd-parity tensor without inversion symmetry, similar to an electric field.

Recently, notable progresses have been achieved in issue of mechanical switching of ferroelectric domains.^{16–30} On the experimental front, Lu *et al.*¹⁶ for the first time demonstrated that the stress gradient generated by the tip of an atomic force microscope (AFM) can switch the polarization locally in BaTiO₃ (BTO) thin film. Afterwards, a number of works have been performed, demonstrating the feasibility of mechanical switching in ferroelectric polymer films,^{17,18} thick films,¹⁹ multiferroic thin films,^{20,21} semiconducting films,²² *etc.* The effects of substrate misfit strain^{23,24} and loading mode (*i.e.*, perpendicular mechanical load *vs.* sliding load)²⁵ on the mechanical switching behavior, and the asymmetric feature of mechanical switching in the vicinity of an existing domain wall,²⁶ have been explored. On the theoretical aspect, a number of works based on methods such as finite element simulations,^{16,25} molecular dynamics simulation,²⁶ phase-field method,^{27–29} first-principles calculation,³⁰ *etc.*, have also been performed to gain a deep insight into the mechanism of mechanical switching. It should be pointed out that previous works mainly focused on mechanical switching in thin films under perpendicular tip-loading mode or bending mode, where flexoelectric field due to the transverse and longitudinal strain/stress gradients is believed to be important. In such cases, the shear strain/stress gradient is at least an order smaller in magnitude and its influence is negligible. As two exceptional cases, Očenášek *et al.*²⁵ have shown that shear strain gradient can play a dominant role over compressive strain gradient in the flexoelectric domain switching process under sliding loading mode; Li *et al.*³⁰ have studied the shear strain gradient effect on the polarization reversal of BTO thin films. Also noteworthy is that, for systems with surfaces or interfaces, other effects beyond flexoelectricity such as surface piezoelectricity,³¹ interfacial bonding and screening effect,^{32,33} contact electrification,³⁴ and surface electrochemical process³⁵ are possible to be modified by mechanical fields to facilitate mechanical switching of ferroelectric domain. For example, a recent work has shown that mechanical switching driven by depolarization field can be achieved in ferroelectric thin films, with both up-to-down and down-to-up switching modes and a hidden nonlocal switching

mode.³³ Considering the controversy in the literature on the magnitude of flexoelectric coefficients and many other possible sources that may affect domain switching, it is of significance to reveal other possible mechanical switching mechanisms.

In this work, based on thermodynamic calculation and phase-field simulation, we showed an overlooked mechanism of mechanical switching of polarization in BTO *via* shear stress engineering. In this mechanism, the trilinear coupling between shear stress and the two polarization components that lie in the shear strain plane is exploited, and the presence of flexoelectricity is not necessary. Specifically, when the direction of one polarization component is fixed, switching of the other component can be induced by applying a shear stress. Moreover, when the shear stress is fixed, switching of one of the polarization components can lead to the switching of the other component. The stable polarization state as a function of shear stress, temperature and electric field is calculated. Phase-field simulation is then performed to verify the shear-stress-induced domain switching in ferroelectric thin film. Besides the normal switching where neutral domain walls are involved, a deterministic writing of charged domain walls can be also achieved *via* the combining application of shear stress and electric field. This should be very useful for the fabrication of domain wall devices. At the end, we discuss that such a shear-stress-modified polarization switching can provide us a novel design of vortex memory device.

Model and methodology

Thermodynamic model

We model the thermodynamics of ferroelectrics based on the phenomenological Landau–Devonshire theory. The quantities such as polarization and stress are described in a Cartesian coordinate system (Fig. 1a). To consider the response of a thermodynamic system in response to external stress and electric field, here we adopt the Gibbs free energy. Taking the state of the paraelectric crystal at zero stress and electric field as the reference, the free energy density of a ferroelectric crystal as a function of polarization, stress and electric field is written as,³⁶

$$G = \frac{1}{2}\alpha_{ij}P_iP_j + \frac{1}{4}\alpha_{ijkl}P_iP_jP_kP_l + \frac{1}{6}\alpha_{ijklmn}P_iP_jP_kP_lP_mP_n - \frac{1}{2}s_{ijkl}\sigma_{ij}\sigma_{kl} - \frac{1}{2}Q_{ijkl}\sigma_{ij}P_kP_l - E_iP_i + \dots \quad (1)$$

where ellipsis ‘...’ means higher order terms, α_{ij} , α_{ijkl} and α_{ijklmn} are the phenomenological Landau–Devonshire coefficients, s_{ijkl} is the elastic compliance tensor, Q_{ijkl} is the electrostrictive constant tensor, σ_{ij} is the stress tensor, and E_i is the electric field vector. Note that all the indexes are in range 1–3, and the number 1, 2 and 3 correspond to the coordinate x , y and z , respectively.

For BTO, an eight-order Landau–Devonshire potential is usually employed.³⁷ For simplicity, we consider that the BTO crystal is subjected to a uniform shear stress σ_{zx} , and an external electric field along the z -axis E_z . The explicit expression of the free energy density is then given by



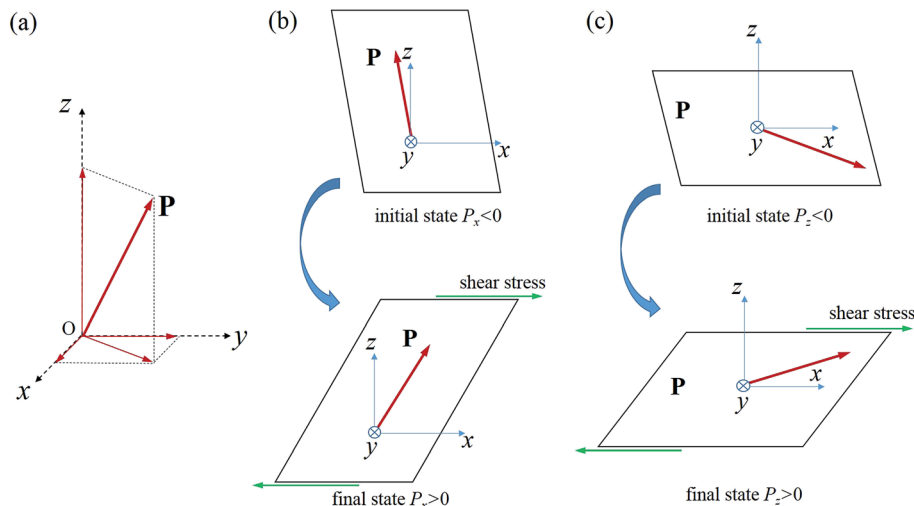


Fig. 1 (a) Schematic of a polarization vector in a Cartesian coordinate system. (b and c) Schematic of two possible switching behaviors of a polarization vector (P_x, P_z) by shear stress σ_{zx} . (b) Switching from (P_x, P_z) into $(-P_x, P_z)$, and (c) switching from (P_x, P_z) into $(P_x, -P_z)$.

$$\begin{aligned}
 G = & a_1 \sum_i P_i^2 + a_{11} \sum_i P_i^4 + a_{12} \sum_{i>j} P_i^2 P_j^2 + a_{111} \sum_i P_i^6 \\
 & + a_{112} \sum_{i>j} (P_i^4 P_j^2 + P_j^4 P_i^2) + a_{123} \prod_i P_i^2 + a_{1111} \sum_i P_i^8 \\
 & + a_{1112} \sum_{i>j} (P_i^6 P_j^2 + P_j^6 P_i^2) + a_{1122} \sum_{i>j} P_i^4 P_j^4 \\
 & + a_{1123} \sum_{i \neq j \neq k, j > k} P_i^4 P_j^2 P_k^2 - \frac{1}{2} s_{44} \sigma_{zx}^2 - \frac{1}{2} Q_{44} \sigma_{zx} P_x P_z - E_z P_z
 \end{aligned} \quad (2)$$

where $a_1, a_{11}, a_{12}, a_{111}, a_{112}, a_{123}, a_{1111}, a_{1112}, a_{1122}$, and a_{1123} are the nontrivial Landau–Devonshire coefficients; s_{44} and Q_{44} are the relevant elastic compliance constants and the electrostrictive constants written in Voigt notation.

It can be seen from eqn (2) that the two polarization components, P_x and P_z , and the shear stress σ_{zx} are coupled with each other in a trilinear form $-\frac{1}{2}Q_{44}\sigma_{zx}P_xP_z$. This coupling term, together with the last term, $-E_zP_z$, enforces a condition of the sign of these three quantities. The other terms of the free energy density do not depend on the signs of P_x, P_z , and σ_{zx} . That is to say, once the signs of two of them are fixed, the sign of the third one cannot change arbitrarily, as required by the energy minimum principle. This condition provides us the mechanism of polarization switching by shear stress as schematically shown in Fig. 1b. Specifically, two possible switching behaviors of a polarization vector (P_x, P_z) can be expected, depending on the relative stability of the two polarization components. In the first case, the polarization component P_z is more stable, and the application of shear stress σ_{zx} leads to the switching of P_x . In the second case, the polarization component P_x is more stable, and the application of shear stress σ_{zx} leads to the switching of P_z . Note that it is the trilinear term that determines the relative signs of P_x, P_z , and σ_{zx} , as it is the only term that links the three quantities, meanwhile the relative stability of the two polarization components can be modified by external electric field *via* the last term. Other factors, such as temperature, misfit strain,

screening condition, *etc.*, can also modify the relative stability of the two polarization components.

The equilibrium polarization state can be obtained by minimizing the free energy density G in eqn (2), $\partial G/\partial P_i = 0$, *i.e.*,

$$\begin{aligned}
 & 2a_1P_x + 4a_{11}P_x^3 + a_{12}P_x(P_y^2 + P_z^2) + 6a_{111}P_x^5 \\
 & + a_{112}[4P_x^3(P_y^2 + P_z^2) + 2P_x(P_y^4 + P_z^4)] \\
 & + 2a_{123}P_xP_y^2P_z^2 + 8a_{1111}P_x^7 + a_{1112}[6P_x^5(P_y^2 + P_z^2) \\
 & + 2P_x(P_y^6 + P_z^6)] + 4a_{1122}P_x^3(P_y^4 + P_z^4) \\
 & + 4a_{1123}P_x^3P_y^2P_z^2 + 2a_{1123}P_x(P_y^4P_z^2 + P_y^2P_z^4) \\
 & - \frac{1}{2}Q_{44}\sigma_{zx}P_z = 0
 \end{aligned} \quad (3a)$$

$$\begin{aligned}
 & 2a_1P_y + 4a_{11}P_y^3 + a_{12}P_y(P_x^2 + P_z^2) + 6a_{111}P_y^5 \\
 & + a_{112}[4P_y^3(P_x^2 + P_z^2) + 2P_y(P_x^4 + P_z^4)] \\
 & + 2a_{123}P_yP_x^2P_z^2 + 8a_{1111}P_y^7 + a_{1112}[6P_y^5(P_x^2 + P_z^2) \\
 & + 2P_y(P_x^6 + P_z^6)] + 4a_{1122}P_y^3(P_x^4 + P_z^4) \\
 & + 4a_{1123}P_y^3P_x^2P_z^2 + 2a_{1123}P_y(P_x^4P_z^2 + P_x^2P_z^4) = 0
 \end{aligned} \quad (3b)$$

$$\begin{aligned}
 & 2a_1P_z + 4a_{11}P_z^3 + a_{12}P_z(P_x^2 + P_y^2) + 6a_{111}P_z^5 \\
 & + a_{112}[4P_z^3(P_x^2 + P_y^2) + 2P_z(P_x^4 + P_y^4)] \\
 & + 2a_{123}P_zP_x^2P_y^2 + 8a_{1111}P_z^7 + a_{1112}[6P_z^5(P_x^2 + P_y^2) \\
 & + 2P_z(P_x^6 + P_y^6)] + 4a_{1122}P_z^3(P_x^4 + P_y^4) + 4a_{1123}P_z^3P_x^2P_y^2 \\
 & + 2a_{1123}P_z(P_x^4P_y^2 + P_x^2P_y^4) - \frac{1}{2}Q_{44}\sigma_{zx}P_x - E_z = 0
 \end{aligned} \quad (3c)$$



The application of shear stress σ_{zx} and electric field E_z lowers the degeneracy of the ferroelectric phases of BTO. To classify the different phases, we introduce the following notations: (i) the c-phase, where $P_x = P_y = 0$ and $P_z \neq 0$; (ii) the O-phase, where $|P_x| = |P_z| \neq 0$ and $P_y = 0$; (iii) the r_1 -phase, where $|P_x| = |P_y| = |P_z| \neq 0$; (iv) the r_2 -phase, where $P_x = -P_z \neq 0$, and $P_y \neq 0$; (v) the r_3 -phase, where $P_x = P_z \neq 0$, and $P_y \neq 0$; (vi) the ac_1 -phase, where $|P_x| \neq |P_z|$, $P_x P_z < 0$ and $P_y = 0$; (vii) the ac_2 -phase, where $P_x = -P_z \neq 0$ and $P_y = 0$; (viii) the ac_3 -phase, where $|P_x| \neq |P_z|$, $P_x P_z > 0$ and $P_y = 0$; and (ix) the ac_4 -phase, where $P_x = P_z \neq 0$ and $P_y = 0$. Values of expansion coefficients of the eight-order approximated potential for BTO are from ref. 37, and those of the electrostrictive coefficients and the elastic compliance coefficients are from ref. 38.

Phase-field simulation

We construct a phase-field model to investigate the domain switching behavior of BTO thin film subjected to a local shear stress. In this model, the temporal evolution of the spontaneous polarization field is described by the time-dependent Ginzburg–Landau (TDGL) equations,

$$\frac{\partial P_i(\mathbf{r})}{\partial t} = -M \frac{\delta F}{\delta P_i(\mathbf{r})} \quad (4)$$

where F is the total free energy of the system, M is a kinetic coefficient and t is time.

The total free energy is a sum of the Landau free energy F_{Land} , elastic energy F_{elas} , gradient energy F_{grad} , electrostatic energy F_{elec} and surface energy F_{surf} , that is,

$$F = \int_V (f_{\text{Land}} + f_{\text{elas}} + f_{\text{grad}} + f_{\text{elec}}) dV + \int_S f_{\text{surf}} dS \quad (5)$$

where f_{Land} , f_{grad} , f_{elas} , f_{elec} and f_{surf} are the corresponding energy densities, and V and S are the volume and the surface of the nanofilm, respectively.

The Landau energy density f_{Land} is taken to be at zero stress and zero electric field, that is, the one given in eqn (2) with the elastic and the electric terms excluded. Under the condition of applied stress, the mechanical stress field (applied and internal) and its coupling with the polarization field contribute to the elastic energy density, which is given by,

$$f_{\text{elas}} = -Q_{ijkl} \sigma_{ij}(\mathbf{r}) P_k(\mathbf{r}) P_l(\mathbf{r}) - \frac{1}{2} s_{ijkl} \sigma_{ij}(\mathbf{r}) \sigma_{kl}(\mathbf{r}) \quad (6)$$

In the absence of body forces, the inhomogeneous stress field $\sigma_{ij}(\mathbf{r})$ is calculated by solving the mechanical equilibrium equation, *i.e.*, $\sigma_{ij,j}(\mathbf{r}) = 0$, where the comma in the subscript denotes spatial differentiation. Here the thin film is assumed to be epitaxially grown on an elastic substrate. The film/substrate system is subjected to the contact force of an AFM tip with a trend of relative motion along the film surface. The mechanical boundary at the top surface is given by $n_i \sigma_{ik} = \tau_k$, where τ_k is the local surface traction caused by the tip force and n_i is the i th component of the unit vector normal to the surface. Specifically, the local surface traction consists of a normal component τ_z and a lateral component τ_{xy} , corresponding to a compression force F_p

and a friction force F_f , respectively. In calculating the stress field, a thick-enough layer of substrate is included and the bottom boundary of the film/substrate system is fixed in displacement. For simplicity, the elastic property of the substrate is taken to be the same with that of the ferroelectric thin film.

The gradient energy, or called domain wall energy, is caused by the inhomogeneity of the polarization field. For a perovskite ferroelectric such as BTO, to the lowest order of the Taylor expansion, the gradient energy density takes the form as

$$\begin{aligned} f_{\text{grad}} = & \frac{1}{2} G_{11} (P_{x,x}^2 + P_{y,y}^2 + P_{z,z}^2) \\ & + G_{12} (P_{x,x} P_{y,y} + P_{y,y} P_{z,z} + P_{x,x} P_{z,z}) \\ & + \frac{1}{2} G_{44} [(P_{x,y} + P_{y,x})^2 + (P_{y,z} + P_{z,y})^2 + (P_{x,z} + P_{z,x})^2] \\ & + \frac{1}{2} G'_{44} [(P_{x,y} - P_{y,x})^2 + (P_{y,z} - P_{z,y})^2 + (P_{x,z} - P_{z,x})^2] \end{aligned} \quad (7)$$

where G_{11} , G_{12} , G_{44} , and G'_{44} are gradient energy coefficients, and $P_{i,j}$ denotes the derivative of the i th component of the polarization vector, P_i , with respect to the j th coordinate.

The electric energy density of a given polarization distribution is given by

$$f_{\text{elec}} = -\mathbf{P} \cdot \mathbf{E} - \frac{1}{2} \varepsilon_b \mathbf{E}^2 \quad (8)$$

where ε_b of about $50\varepsilon_0$ is the dielectric constant of the background material.^{39,40} For a nanofilm subjected to an external electric field $\mathbf{E}_a$, the total electric field $\mathbf{E}$ is equal to sum of the external field $\mathbf{E}_a$ and the depolarization field $\mathbf{E}_d$. E can be calculated by the electrostatic equilibrium equation for a free-charge-absent body as

$$\mathbf{D}_{i,i} = (\varepsilon_b \mathbf{E} + \mathbf{P})_{i,i} = 0 \quad (9)$$

Due to truncation at the surface of the nanofilm, the spontaneous polarizations are inhomogeneous across the out-of-plane direction. Thus an additional surface energy is necessary to describe this intrinsic effect. Using the effective extrapolation length δ_i^{eff} , the surface energy density can be approximately given by

$$f_{\text{surf}} = \frac{D_{11} P_1^2}{2\delta_1^{\text{eff}}} + \frac{D_{22} P_2^2}{2\delta_2^{\text{eff}}} + \frac{D_{44} P_3^2}{2\delta_3^{\text{eff}}} \quad (10)$$

where D_{11} , D_{22} and D_{44} are the material coefficients related to the gradient energy coefficients.

Phase-field simulation of domain switching of BTO thin film is performed by numerically solving the TDGL equations (eqn (4)) together with the mechanical and electrostatic equilibrium equations. For simplicity, a two-dimensional (2D) mesh along x and z direction is adopted. Thickness of the BTO film is taken to be 12 nm, and that of the substrate layer is taken to be 36 nm. The lateral size of the simulation cell is set to be 200 nm. A periodic boundary condition is applied along the x direction. The TDGL equations are solved by using an explicit Euler iterative scheme, whereas the mechanical and electrostatic



equilibrium equations are solved by a finite element method (FEM). Values of the expansion coefficients of the Landau free energy, the electrostrictive coefficients and the elastic compliance coefficients are the same as those adopted in the thermodynamic calculation. Values of the gradient energy coefficients are taken to be: $G_{11} = 5.1 \times 10^{-10} \text{ m}^4 \text{ N C}^{-2}$, $G_{44} = G'_{44} = 1 \times 10^{-11} \text{ m}^4 \text{ N C}^{-2}$, and $G_{12} = 0$.⁴¹ The extrapolation lengths are $\delta_1^{\text{eff}} = \delta_2^{\text{eff}} = \delta_3^{\text{eff}} = 4.3 \times 10^{-8} \text{ m}$.⁴²

Results and discussion

Polarization state of BTO crystal at zero external electric field

We start our investigation on the temperature evolution of the polarization state of BTO crystal subjected to different values of shear stress σ_{zx} but at zero external electric field. For comparison, in Fig. 2a, the temperature evolution of the polarization state of BTO crystal in the absence of shear stress and external electric field is depicted. It can be seen that BTO undergoes a paraelectric-ferroelectric transition at about 395 K. The ferroelectric phase is c-phase at the temperature range of about [280 K, 395 K], O-phase at the temperature range of about [200 K, 280 K], and r_1 -phase at the temperature below 200 K. Note that, in the absence of shear stress and external electric field, polarization states with the polarization components in opposite signs are degenerate as a result of symmetry. Fig. 2b depicts the phase diagram of polarization state of BTO as a function of temperature and shear stress in the absence of external electric field. It can be seen that the application of shear stress lowers the degeneracy of the ferroelectric phases of BTO. In the negative stress regime, phases with the polarization components P_x and P_z in opposite signs are stable. They are ac_1 -phase, ac_2 -phase and r_2 -phase. In contrast, in the positive stress regime, the stable phases are those with the polarization components P_x and P_z in the same signs. They are ac_3 -phase, ac_4 -phase and r_3 -phase. The increase of shear stress magnitude $|\sigma_{zx}|$ from zero to 4 GPa increases the paraelectric-ferroelectric transition temperature from about 395 K to above 520 K, meanwhile it decreases the ac_2/r_2 and the ac_4/r_3 -phase transition temperatures from about 200 K to below 40 K. Note also that ac_1 and ac_3 -phases are stable at relatively high temperature and small stress. With the increase of stress, the stable temperature window of the two phases decreases, forming two inverted triangular regions in the phase diagram.

To see more clearly the change of polarization, in Fig. 3 we depict the temperature evolution of polarization state of BTO under different values of shear stress σ_{zx} and at zero external electric field, with Fig. 3a–d corresponding to $\sigma_{zx} = -0.4 \text{ GPa}$, 0.4 GPa , -2 GPa , and 2 GPa , respectively. Paraelectric-ferroelectric phase transition occurs at a temperature of about 400 K for the cases of $|\sigma_{zx}| = 0.4 \text{ GPa}$, whereas for $|\sigma_{zx}| = 2 \text{ GPa}$ the system exhibits paraelectric-ferroelectric phase transition at about 455 K. Moreover, the paraelectric-ferroelectric phase transition is first-order at $|\sigma_{zx}| = 0.4 \text{ GPa}$ and it turns to be second-order at $|\sigma_{zx}| = 2 \text{ GPa}$. The ferroelectric phases are quite different due to the shear stress. Specifically, at $\sigma_{zx} = -0.4 \text{ GPa}$, the system adopts ac_1 -phase at $T = [325 \text{ K}, 400 \text{ K}]$, ac_2 -phase at $T = [325 \text{ K}, 280 \text{ K}]$, and r_2 -phase at temperature below 170 K. At σ_{zx}

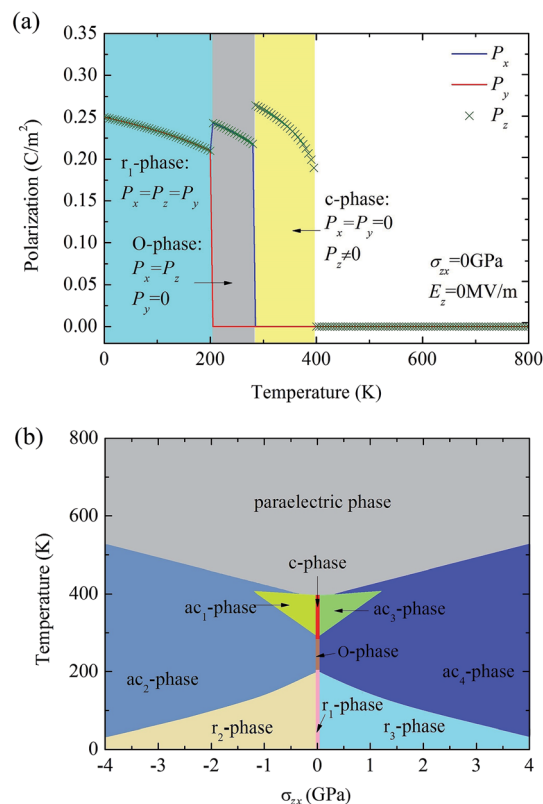


Fig. 2 (a) Temperature evolution of polarization state of BTO in the absence of shear stress and external electric field. (b) Phase diagram of polarization state of BTO as a function of temperature and shear stress in the absence of external electric field.

$= 0.4 \text{ GPa}$, the system adopts ac_3 -phase at $T = [325 \text{ K}, 400 \text{ K}]$, ac_4 -phase at $T = [325 \text{ K}, 280 \text{ K}]$, and r_3 -phase at temperature below 170 K. At $\sigma_{zx} = -2 \text{ GPa}$, the system evolves into ac_2 -phase at about 455 K, then into r_2 -phase at about 95 K. At $\sigma_{zx} = 2 \text{ GPa}$, the system evolves into ac_4 -phase at about 455 K, then into r_2 -phase at about 95 K. For negative stress $\sigma_{zx} < 0$, the two components P_x and P_z are always in opposite signs, i.e., $P_x P_z < 0$, whereas for positive stress $\sigma_{zx} > 0$, they are always in positive signs, i.e., $P_x P_z > 0$. The change of direction of the two polarization components due to the change of sign of shear stress is clearly seen.

Polarization state of BTO crystal at nonzero external electric field

Note that while the above result indicates the feasibility of changing the relative sign of the two polarization components by shear stress, it is not deterministic which polarization component would change its sign when shear stress applies. This is due to the fact that, phases with $P_x > 0$, $P_z < 0$ or $P_x < 0$, $P_z > 0$ are possible at negative shear stress, meanwhile, phases with $P_x > 0$, $P_z > 0$ or $P_x < 0$, $P_z < 0$ are possible at positive shear stress. In practice, the direction of which polarization component will be switched depends on the relative stability of the two polarization components (see, Fig. 1b). Such relative stability can be modified by many factors, such as temperature, depolarization field,



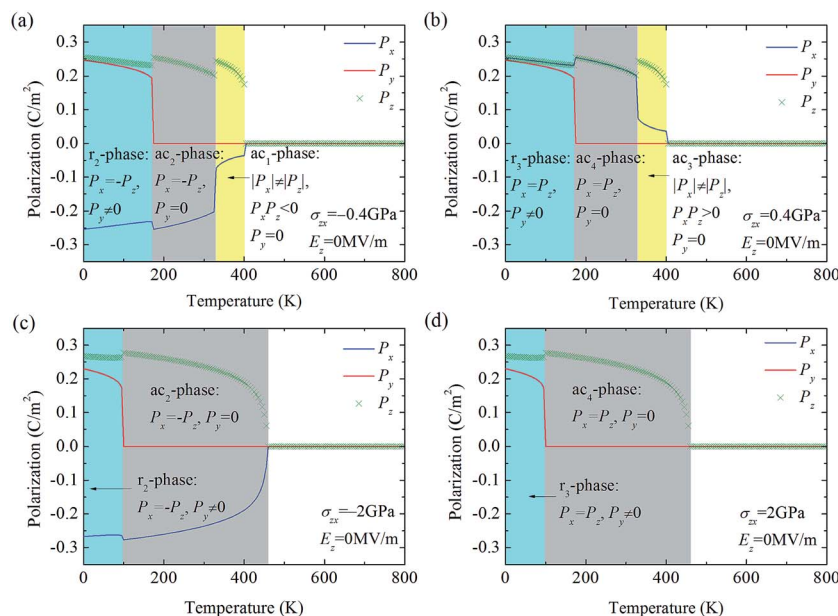


Fig. 3 Temperature evolution of polarization state of BTO under different values of shear stress σ_{zx} and at zero external electric field. (a) $\sigma_{zx} = -0.4$ GPa, (b) $\sigma_{zx} = 0.4$ GPa, (c) $\sigma_{zx} = -2$ GPa and (d) $\sigma_{zx} = 2$ GPa.

external electric field, and misfit strain. Take ferroelectric thin film as an example. The more stable polarization direction can be tuned from out-of-plane to in-plane when the misfit strain changes from compression to tension. Another possible effect that can lead to a deterministic switching is that the degeneracy of the polarization states with opposite polarization component is broken. For example, due to the application of an external field along positive z direction, states with $P_z > 0$ should be more stable than states with $P_z < 0$. As a result, a switching from states with $P_z > 0$ to states with $P_z < 0$ is not likely to trigger by the shear stress, hence P_x rather than P_z would change sign. To see it more clearly, Fig. 4 depicts the stable polarization vector of BTO as a function of shear stress σ_{zx} and external electric field E_z at room temperature. Result shows that due to the external electric field, the direction of P_z component is controlled by the external field. Consequently, the direction of P_x component depends on the sign of the shear stress. A deterministic switching of the P_x component is thus achieved. Note that, besides the application of external field, the penalty of domain wall energy can also cause a broken degeneracy of the polarization states. A deterministic switching of the polarization can occur in a natural way without the need of an external field. This point will be clarified later by our phase-field simulation.

Moreover, Fig. 4 also indicates that when the shear stress σ_{zx} is fixed, the change of external field E_z can lead to switching of P_z component together with the switching of P_x component. Therefore, shear stress can lead to a switching of in-plane polarization by an out-of-plane electric field. To see more clearly, in Fig. 5 we depict the polarization state of BTO as a function of external electric field under different values of shear stress σ_{zx} and at room temperature, with Fig. 5a–d corresponding to $\sigma_{zx} = -0.4$ GPa, 0.4 GPa, -2 GPa, and 2 GPa, respectively. It can be seen that while P_z component changes its

sign with the inversion of the external field, P_x also changes its sign with the inversion of the external field. Moreover, the signs of P_x and P_z are either the same or opposite depending on the shear stress. Note also that while the magnitude of P_z increases as the external field increases, the magnitude of P_x decreases with the external field. Such a change of the magnitude of P_x can exhibit either a linear feature (see, Fig. 5c and d for $|\sigma_{zx}| = 2$ GPa) or a nonlinear feature (see, Fig. 5a and b for $|\sigma_{zx}| = 0.4$ GPa) depending on the magnitude of the shear stress.

Shear-stress-induced domain switching in ferroelectric thin film

The effects of shear stress/strain on polarization stability have been discussed by several works.^{25,30,43–45} Particularly, using a thermodynamic model, Zembilgotov *et al.*⁴³ have calculated the phase diagrams of the stable polarization state in epitaxial films subjected to an in-plane misfit shear strain. Gruverman *et al.*⁴⁴ observed that polarization switching could occur far beyond the tip contact area in polycrystalline films. Shear stress deformation of the grain underneath the tip was believed to cause this abnormal switching behavior. More recently, it has been shown that shear strain gradient can play a dominant role over compressive strain gradient in the flexoelectric domain switching process.²⁵ First-principle calculation has been also applied to reveal the shear-strain gradient induced polarization reversal in BTO thin films.³⁰ These works indicate that shear stress/strain (gradient) can be effective to control the polarization stability of ferroelectrics. Here we emphasize that polarization switching can be induced by shear stress, due to the trilinear coupling effect between shear stress and the two polarization components that lie in the shear strain plane. This shear stress effect has been overlooked in recent discussion on



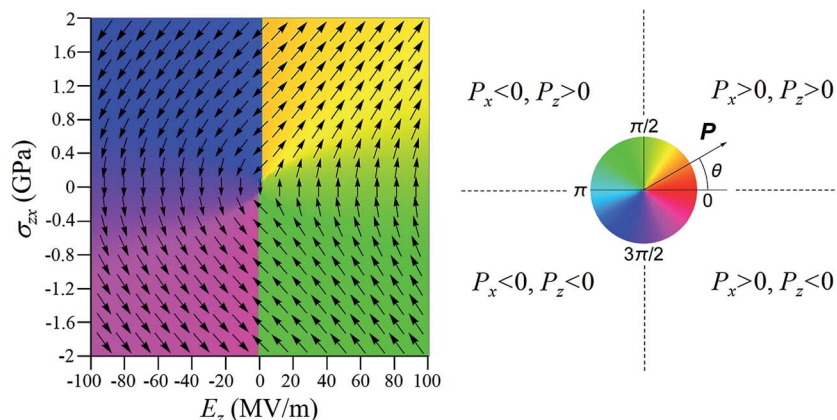


Fig. 4 The stable polarization vector of BTO as a function of shear stress σ_{zx} and external electric field E_z at room temperature (left panel). Different colors correspond to different directions of the polarization vector as defined in the right panel.

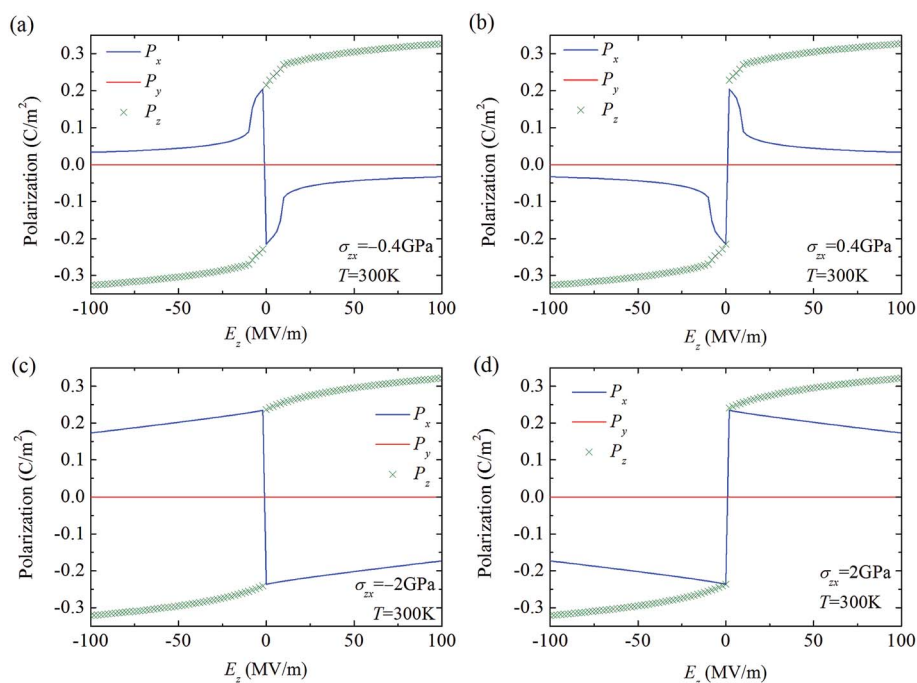


Fig. 5 Polarization state of BTO at room temperature as a function of external electric field E_z under different values of shear stress σ_{zx} . (a) $\sigma_{zx} = -0.4$ GPa, (b) $\sigma_{zx} = 0.4$ GPa, (c) $\sigma_{zx} = -2$ GPa and (d) $\sigma_{zx} = 2$ GPa.

mechanical switching of ferroelectric polarization. Here we would like to first point out some implications of this effect on design of novel devices.

First of all, this effect can be utilized to design generator or sensor devices based on ultrathin ferroelectric films. The merit of such devices lies in the fact that, in ultrathin ferroelectric films, depolarization field tends to force the polarization along the in-plane direction, which leads to a depression of piezoelectric response that utilizes the coupling of out-of-plane strain and polarization. In contrast, piezoelectric response based on the shear mode can enter into the role. This should have potential applications such as power generation or state detection of fluids where shear flow is important. Another potential application of

the shear-stress-modified polarization switching effect is memory device. One possible working mode of the memory device is that exploits mechanical switching of the domain information without the need of external electric field. Domain switching can be induced in a thin film with orthorhombic or rhombohedral single-domain state, by exerting a local shear stress to the film. The local shear stress may be generated by the friction force *via* an AFM tip working at the sliding loading mode, or even under perpendicular loading mode. This is due to the fact that two shear stress regions with significant values can be induced inside a film when it is subjected to a compression tip force. Note that the contribution of shear stress to domain switching would be much less important for the switching of tetragonal single-



domain state, as it is based on the coupling between two polarization components. Another possible working mode is that exploits the complicate domain switching behavior under the combining application of local shear stress and external electric field, which may be applied by a biased AFM tip working at the sliding mode. Note that for such a working mode, head-to-head or tail-to-tail charged domain walls can be generated in a deterministic way according to the result shown in Fig. 4. Such charged domain walls can be stabilized in samples with enough free charge carriers. This should be very useful for the design of domain-wall-based memory devices.

To verify the feasibility of domain switching *via* shear stress, we further perform phase-field simulation on a 12 nm-thick BTO thin film under the contact of an AFM tip (with a radius of 50 nm) at the film surface. The AFM tip is subjected to a compression force F_p along the film thickness direction (*i.e.*, negative z direction), which imposes a nonuniform surface traction τ_z within the contact region. Moreover, the tip has a trend of relative motion along the film surface (*i.e.*, positive or negative x direction). This leads to a lateral surface traction τ_x due to the static friction. Assuming that the static friction coefficient is μ , we have $\tau_x = \mu\tau_z$, and the static friction force $F_f = \mu F_p$. Fig. 6 depicts the distributions of stress components σ_{zz} and σ_{zx} in the film under a tip force $F_p = 1.8 \mu\text{N}$ with a trend of relative motion along the negative x direction. It can be seen that the tip force induces a compressive stress state σ_{zz} along the film direction right below the tip (Fig. 6a). Moreover, it also causes two shear stress regions with σ_{zx} taking opposite signs in the film at the two sides of the tip (Fig. 6b). Due to the trend of relative motion along the negative x direction, the magnitude of shear stress at the left side (in front of the tip) is much larger than that at the right side (behind the tip).

In the following, we explore if domain switching can occur at the enhanced shear stress region. The electric boundary condition at the top and bottom surfaces of the film is set to be short-circuited. The simulation temperature is set to be 100 K and the misfit strain is -0.002 so that the film can be stabilized in a rhombohedral phase. The thin film is initially set into a single-domain state with $P_x > 0$ and $P_z > 0$. The evolution of this single-domain state in response to the tip force shown above is

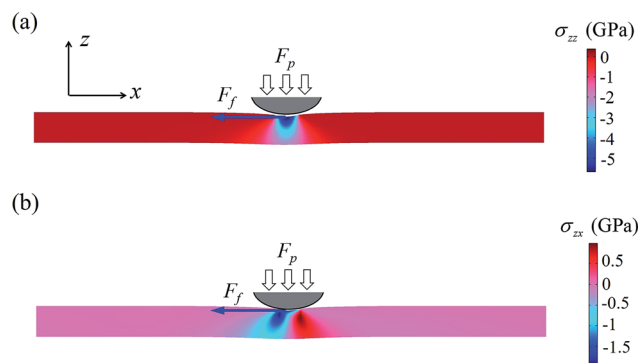


Fig. 6 Distributions of stress components (a) σ_{zz} and (b) σ_{zx} in a 12 nm-thick BTO film under a tip force $F_p = 1.8 \mu\text{N}$. The tip has a trend of relative motion along the negative x direction.

simulated and the result is shown in Fig. 7a. In response to the local shear stress $\sigma_{zx} < 0$, the polarization field nearby the stress-applied region is expected to be switched into $P_x < 0$ and $P_z > 0$, or $P_x > 0$ and $P_z < 0$. However, in fact, the polarization field is definitely switched into $P_x > 0$ and $P_z < 0$; otherwise, head-to-head and tail-to-tail charged domain walls will appear, which violates the energy minimization principle. An up-to-down domain switching thus can occur at the shear stress region with $\sigma_{zx} < 0$. This is exactly the case we found in Fig. 7a. One can see that, as the tip force is applied, the polarization field below the tip becomes mainly along the in-plane direction due to the large compressive stress. Moreover, the polarization field near the left side of the tip (*i.e.*, at the enhanced shear stress region with $\sigma_{zx} < 0$) is switched to negative z direction. After the tip force is switched off, a switched domain with $P_x > 0$ and $P_z < 0$ is formed slightly ahead of the tip. Similarly, we also simulate the case where the thin film is initially set into a single-domain state with $P_x > 0$ and $P_z < 0$, and the trend of relative motion is changed to be along the positive x direction. As shown in Fig. 7b, a down-to-up domain switching has been triggered by a local tip force. For this case, the switched domain with $P_x > 0$ and $P_z > 0$ is formed, and its location is also slightly ahead of the tip. Note that our result shows that shear stress can lead to both up-to-down and down-to-up domain switching, which is determined by the sliding direction and the polarization direction of domain. This is different from flexoelectric domain switching in tip-film architecture, where the directions of strain gradients and flexoelectric field are fixed, thus one can only expect either up-to-down or down-to-up switching. Note also that, for a film under sliding load, previous work showed that the domain switching due to flexoelectric field includes a region behind the sliding tip, which is determined by the distribution of the shear strain gradient.²⁵ This is in contrast to our case, where the switched domain is slightly ahead of the tip, as determined by the

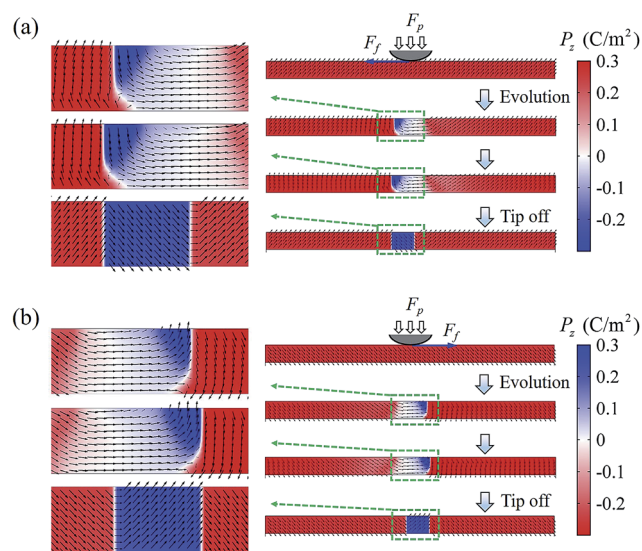


Fig. 7 Phase-field simulation result of domain switching in a 12 nm-thick BTO thin film subjected to a tip force $F_p = 1.8 \mu\text{N}$. (a) Up-to-down domain switching for the tip with a trend of relative motion along the negative x direction (b) down-to-up domain switching for the tip with a trend of relative motion along the positive x direction.



distribution of the shear stress and the direction of the polarization field (Fig. 6b). In practice, the feasibility of bi-directional switching and the location of switching domain could be evidences of mechanical switching beyond flexoelectricity.

As pointed out previously, it is also possible to generate charged domain walls in thin film under the combining effect of shear stress and external electric field. To see this, we perform another simulation, with all of the setting similar to the case shown in Fig. 7a, except that now an external electric field $E_z = 3 \times 10^8 \text{ V m}^{-1}$ is also applied to the thin film (at the middle region of the film with a width 80 nm), mimicking a biased tip working at the sliding mode. The simulation result is shown in Fig. 8. It can be seen that the polarization field nearby the stress and field applied region is switched into $P_x < 0$ and $P_z > 0$, with the appearance of tail-to-tail and head-to-head alike domain walls between the switched domain and the unswitched domains, in contrast to the case shown in Fig. 7a where charge neutral domain walls are formed instead. The difference is due to the fact that, the direction of polarization component P_z is fixed here due to the external electric field, therefore the polarization component P_x has to be switched by the shear stress according to the trilinear coupling. It should be pointed out that the shear-stress-induced charged domain walls we found here is not strictly tail-to-tail and head-to-head to avoid the depolarization energy (as no free charge carriers is assumed), and the domain walls would not maintain stable after tip force and field is switched off. Nevertheless, such charged domain walls in practice could be stabilized by free charges and mobile charge defects such as oxygen vacancies in the ferroelectric film, similar to those reported in previous experimental works.^{46–50} Our result thus indicates a novel method to write charged domain walls.

Shear-stress-induced vortex switching in ferroelectric nanoring

Finally, it is noteworthy that the trilinear coupling between the shear stress and the polarization components also indicates

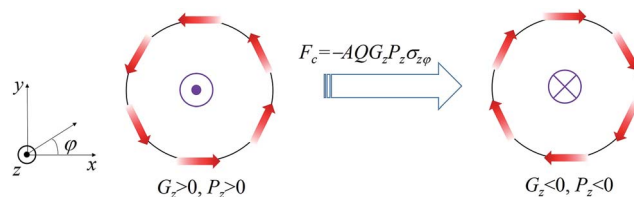


Fig. 9 Schematic of vortex switching in a ferroelectric nanoring based on the trilinear coupling between toroidization G_z , polarization component P_z , and shear stress $\sigma_{\varphi\varphi}$.

a potential strategy of switching the chirality of ferroelectric vortices. Although it is very attractive to utilize the chirality of ferroelectric vortices to develop high-density information storage, switching of the vortex chirality is challenged so far. This is due to the lack of a bilinear coupling between the electric field without curl and the toroidization. Here we show that shear stress might help solve the problem. The basic idea is schematically illustrated in Fig. 9, where switching of the vortex formed in a ferroelectric nanoring with a radius R is taken as an example. The system is placed in a cylindrical coordinate system (ρ, φ, z) . For simplicity, we assume that the nanoring has a uniform polarization P_φ along the angular direction, and is subjected to a shear stress $\sigma_{\varphi z}$, which can be exerted by a torque to the nanoring. The toroidization of the nanoring is given by $G_z = V^{-1} \iiint_V \mathbf{r} \times \mathbf{P} dV \approx RP_\varphi$. Then we apply an external field along the z direction so that the polarization component P_z is induced. The coupling energy density between the shear stress and the two polarization components is $f_c = -Q\sigma_{\varphi z}P_\varphi P_z$, with Q being the electrostrictive constant. After integrating f_c over the volume of the nanoring, one can obtain the coupling energy $F_c = \iiint_V f_c dV = -AQ\sigma_{\varphi z}G_zP_z$, with A being a constant related to the geometry parameters of the ring. Therefore, the toroidization G_z , the polarization P_z and the shear stress $\sigma_{\varphi z}$ are coupled in a trilinear form. For a fixed shear stress $\sigma_{\varphi z}$, a change sign of P_z , which is controlled by the external electric field, can lead to a change sign of the toroidization G_z . Moreover, if the external electric field is fixed so that P_z is fixed in sign, a change sign of shear stress $\sigma_{\varphi z}$ can also lead to a reversal of the toroidization G_z . Note that a polar-toroidal state ($G_z \neq 0, P_z \neq 0$) is necessary for the appearance of the trilinear coupling. Usually one can apply an external field to induce such a polar-toroidal state. In some systems, polar-toroidal state can be spontaneously formed, *e.g.*, in ferroelectric/paraelectric nanowires.⁵¹ In a future simulation work, we would like to show that these systems are promising to realize electric and mechanical switching of the vortex chirality. The feasibility of a simple switching strategy of the chirality of ferroelectric vortices should be very useful for vortex memory devices.

Conclusions

Thermodynamic calculation and phase-field simulation have been performed to reveal the effect of shear stress on the polarization switching behavior in ferroelectric with orthorhombic or rhombohedral phase. Using BTO as an example, we show that switching of polarization can be achieved by shear

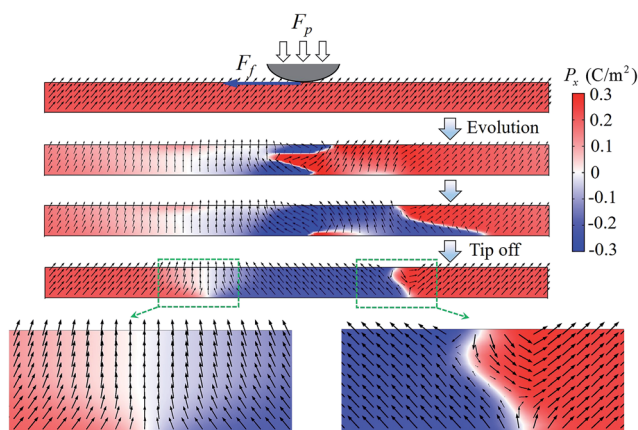


Fig. 8 Phase-field simulation result of domain switching in a 12 nm-thick BTO thin film with the formation of charged domain walls under the combining application of a tip force $F_p = 1.8 \mu\text{N}$ and an external electric field $E_z = -3 \times 10^8 \text{ V m}^{-1}$. The tip has a trend of relative motion along the negative x direction.



stress *via* a simple mechanism. In this mechanism, the trilinear coupling between shear stress and the two polarization components that lie in the strain plane is exploited. Phase diagrams of polarization state as a function of shear stress, temperature and electric field are calculated. The shear-stress-induced domain switching in ferroelectric thin film is verified by phase-field simulation. In addition to the normal domain switching where neutral domain walls are involved, abnormal domain switching with the formation of charged domain walls can be achieved *via* the combining application of shear stress and electric field. The role of shear stress in the feasibility of chirality switching of ferroelectric vortices is also discussed. Our work sheds light on the potential use of shear stress or strain in domain engineering of ferroelectrics.

Conflicts of interest

There are no conflicts to declare.

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